Vishay Semiconductors

Hyper Fast Rectifier, 2 x 5 A FRED Pt[®]



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PRODUCT SUMMARY					
Package	SlimDPAK (TO-252AE)				
I _{F(AV)}	2 x 5 A				
V _R	200 V				
V _F at I _F	0.74 V				
t _{rr} (typ.)	16 ns				
T _J max.	175 °C				
Diode variation	Common cathode				

FEATURES

- Hyper fast recovery time
- 175 °C max. operating junction temperature
- Low forward voltage drop reduced Q_{rr} and soft recovery
- Low leakage current
- Very low profile typical height of 1.3 mm
- · Ideal for automated placement
- · Polyimide passivation for high reliability standard
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyper fast recovery rectifiers designed with optimized performance of forward voltage drop, hyper fast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS inverters or as freewheeling diodes. Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Peak repetitive reverse voltage		V _{RRM}		200	V	
Average rectified forward current	per leg	1	T _C = 165 °C	5		
Average rectilied forward current	per device	IF(AV)		10	А	
Non-repetitive peak surge current	per leg	I _{FSM}	T _J = 25 °C	100		
Operating junction and storage temp	peratures	T _J , T _{Stg}		-55 to +175	°C	

ELECTRICAL SPECIFICATIONS (T _J = 25 $^{\circ}$ C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-		
Forward voltage	V _F	I _F = 5 A	-	0.90	1.04		
		I _F = 10 A	-	1.0	1.17	V	
		I _F = 5 A, T _J = 150 °C	-	0.74	0.84		
		I _F = 10 A, T _J = 150 °C	-	0.85	1.05		
Reverse leakage current per leg		$V_{R} = V_{R}$ rated	-	-	4		
	I _R	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	80	μA	
Junction capacitance per leg	C _T	V _R = 200 V	-	17	-	pF	

Revision: 04-May-17 1 Document Number: 95668 For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS			MAX.	UNITS
		$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t =$	= 100 A/µs, V _R = 30 V	-	16	-	
Reverse recovery time	t _{rr}	I _F = 0.5 A, I _R = 1	I _F = 0.5 A, I _R = 1 A, I _{RR} = 0.25 A			25	
Neverse recovery time		T _J = 25 °C		-	21	-	ns -
		T _J = 125 °C		-	30	-	
Deels receivers environt		T _J = 25 °C	I _F = 5 A dI _F /dt = 200 A/μs V _B = 160 V	-	2.5	-	А
Peak recovery current	I _{RRM}	T _J = 125 °C		-	4	-	A
	0	T _J = 25 °C		-	25	-	nC
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	60	-	nc

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C	
Thermal resistance, junction to ambient	R _{thJA} ⁽¹⁾⁽²⁾		-	73	90	°C/W	
Thermal resistance, junction to case, per diode	R _{thJC} ⁽³⁾		-	2.1	2.5	0/10	
Marking device		Case style SlimDPAK (TO-252AE)		10C\	VH02		

Notes

⁽¹⁾ The heat generated must be less than thermal conductivity from junction to ambient; $dP_D/dT_J < 1R_{thJA}$

 $^{(2)}$ Free air, mounted or recommended copper pad area; thermal resistance R_{thJA} - junction to ambient

⁽³⁾ Mounted on infinite heatsink

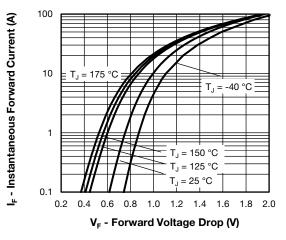


Fig. 1 - Typical Forward Voltage Drop Characteristics

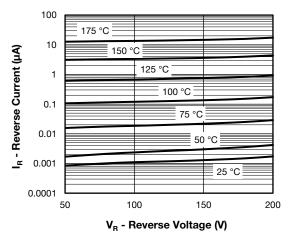


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

VS-10CVH02HM3

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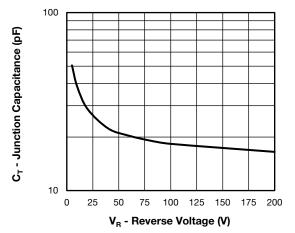


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

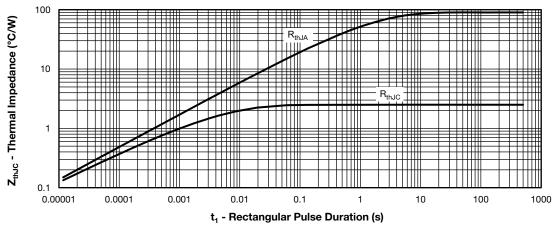
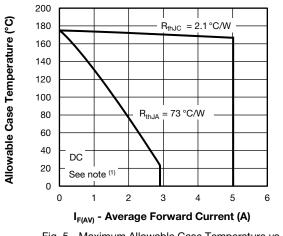
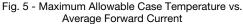


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

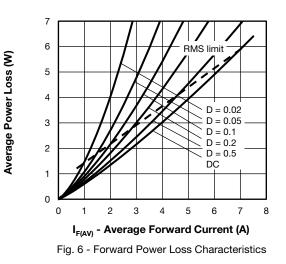


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(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; $Pd = forward power loss = I_{F(AV)} \times V_{FM} at (I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = inverse power loss = V_{R1} \times I_R (1 - D)$; $I_R at V_{R1} = rated V_R$

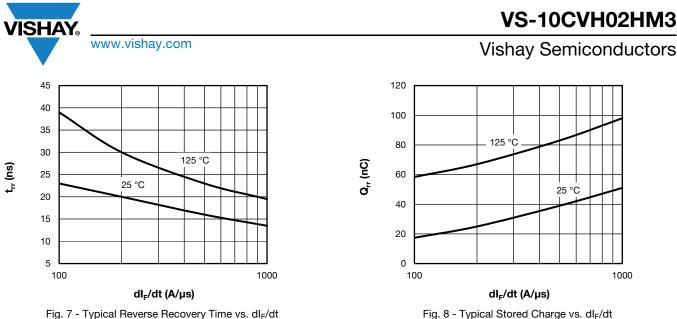


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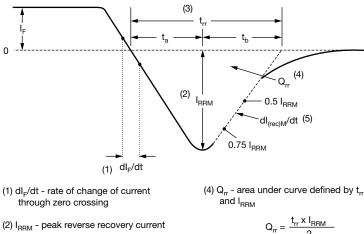
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(3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 $\mathrm{I}_{\mathrm{RRM}}$ and 0.50 $\mathrm{I}_{\mathrm{RRM}}$ extrapolated to zero current.

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) dl_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions





ORDERING INFORMATION TABLE

Device code	VS-	10	С	v	н	02	н	М3
	1	2	3	4	5	6	7	8
	1	- Visl	nay Sen	nicondu	ctors pro	oduct		
	2	- Cur	rent rati	ng (10 =	= 10 A)			
	3	- Circ	uit conf	iguratio	า:			
		C =	commo	n catho	de			
	4	- V =	SlimDP	AK				
	5		cess typ hyper fa	e, ast recov	very			
	6	- Volt	age coo	le (02 =	200 V)			
	7	• H=	AEC-Q	101 qua	lified			
	8	- M3	= halog	en-free,	RoHS-0	complia	nt, and	termina

ORDERING INFORMATION (Example)							
PREFERRED P/N	REFERRED P/N QUANTITY PER REEL MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION						
VS-10CVH02HM3/I	4500	4500	13"diameter plastic tape and reel				

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?96081				
Part marking information	www.vishay.com/doc?96085				
Packaging information	www.vishay.com/doc?88869				





SlimDPAK

DIMENSIONS in inches (millimeters)





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